



UPDATE CHANGE NOTIFICATION # 16760Generic Copy

Issue Date: 17-Nov-2011

TITLE: Update to FPCN16760 – ON Semiconductor Seremban as a second manufacturing Site for 6L TSOP.

PROPOSED FIRST SHIP DATE: 17-Feb-2012 or sooner upon customer's approval

AFFECTED CHANGE CATEGORY(S): On Semiconductor Assembly/Test Site

ADDITIONAL RELIABILITY DATA: Available
Contact your local ON Semiconductor Sales Office or Reliability Engineer Lakshmi Kari,
<Lakshmi.Kari@onsemi.com>

SAMPLES:
Contact your local ON Semiconductor Sales Office or Raj Uppala <raj.uppala@onsemi.com>

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:
Contact your local ON Semiconductor Sales Office or Raj Uppala <raj.uppala@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

DESCRIPTION AND PURPOSE:

This UN is to correct the Title and Description and Purpose stated in FPCN16760:

Before

Title: Product Transfer from HANA to Seremban for 6L TSOP

Description and Purpose:

This Process Change Notice is to notify customers of the Transfer of assembly/test site from HANA, Thailand to ON Semiconductor's, Seremban Malaysia facility.

The devices listed on this FPCN have historically been assembled / tested at the HANA located in Thailand. Due to flooding in Thailand, the assembly/test site in Hana, Thailand is no longer operational. Moving forward, these devices will be processed at ON Semiconductor's, Seremban Malaysia facility.

There will be no changes in device functionality. Reliability will continue to meet or exceed ON Semiconductor's highest standards.

**UPDATE CHANGE NOTIFICATION # 16760****New:**

Title: Semiconductor Seremban as a second manufacturing Site for 6L TSOP

Description and Purpose:

This Process Change Notice is to inform customers that ON Semiconductor is adding ON Semiconductor's Seremban, Malaysia facility as a second manufacturing location for product ASM3P2863AF-06OR.

The devices listed on this FPCN have historically been assembled & tested at the HANA located in Thailand. Due to flooding in Thailand, the assembly/test site in Hana, Thailand is temporarily not in operation. Moving forward, these devices will be processed at either of the location based on the situation.

There will be no changes in device functionality, Reliability will continue to meet or exceed ON Semiconductor's highest standards.

List of affected General Parts:

ASM3P2863AF-06OR